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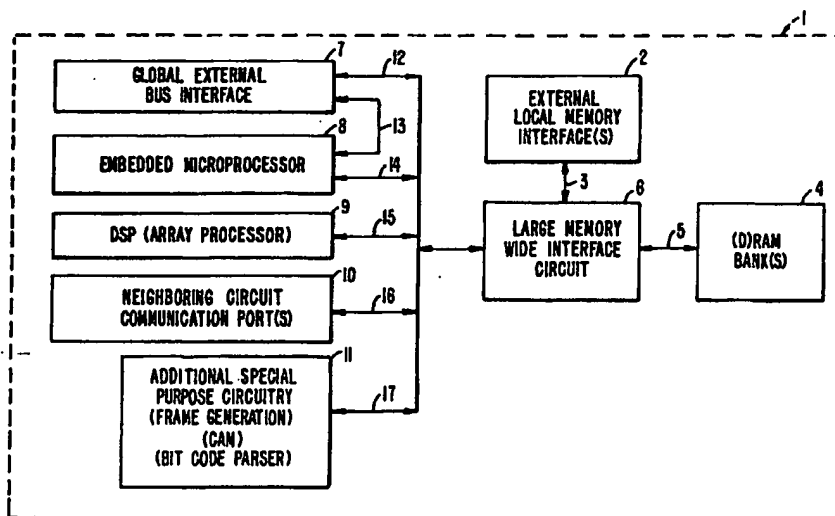
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(57) Abstract

A circuit (1) is provided which contains memory (2), logic, arithmetic and control circuitry needed to generate all or part of a frame for use in video processing and animation as well as digital signal and image processing. One or more such circuits are provided on an integrated circuit (1). A video or image frame generation system is constructed from one or more of these integrated circuits, optionally with additional memory circuitry, to provide exceptional performance in frame production for animation, particularly 3-D and other high performance applications such as medical imaging, virtual reality and real-time scene generation in video games and simulation environments. The circuit(s) are used to process high speed object-oriented graphics related streams such as proposed by MPEG 4, as well as act as a single chip JAVA engine with highly optimized numeric performance.

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VIDEO FRAME RENDERING ENGINE

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STATEMENT OF RELATED APPLICATIONS

This patent application claims priority from U.S. Provisional Applications No. 60/033,476, filed 12/19/96, and No. 60/050,396, filed June 20, 1997. The contents of these
10 provisional applications are herein incorporated by reference in their entirety for all purposes.

BACKGROUND OF THE INVENTION

The present invention relates to circuits. More
15 particularly, the present invention relates to high-performance integrated circuitry suited to the video frame generation task and digital signal processing (DSP) tasks.

The central problem of the graphics industry is to generate frames. Each frame is a rectangular array of pixels, often involving over 1 million pixels. Animation and in
20 particular, 3-D animation, usually requires many millions to many billions of calculations to generate one pixel. Similarly, graphics applications (such as medical imaging) require the generation of one or more frames, again, often in
25 animation sequences.

Consider the example of this need in the 1995 effort by Pixar generating the motion picture Toy Story. There are 110,000 frames in the motion picture. Pixar used 87 dual processor 100 MHz Sparc 20's and 30 quad processor 100 MHz Sparc 20's. This is a total of 294 CPU's. There was an
30 average of 96 Megabytes of RAM per CPU and each processing node had a local 3-5 gigabyte local disk drive. The disk farms and their servers are not relevant to this patent, but were quite large. The entire motion picture took 46 days to
35 compute with an average frame taking between 1 to 3 hours of Sparc CPU processor time. See reference [1].

While Toy Story was not photo-realistic it did represent a breakthrough. It was the first full length,

feature motion picture entirely generated by 3D computer animation technology. Photo-realism for such a film requires at least a factor of 10 more computing complexity. Assume the photo-realistic frames compute in 30 hours.

5 There are many different programs used in frame generation. See references [19]-[23]. These programs are both complex and need high performance. They are created with high level procedural and object-oriented computer programming languages such as C, C++, and FORTRAN. Only the most
10 performance critical portions of these programs might be directly written in assembly/machine language targeting the underlying rendering engine hardware because of the prohibitive expense and difficulty of programming in assembly/machine language. Floating point arithmetic is
15 popular in these programs because of its wide dynamic range and programming ease.

 The need for performance improvements is large. Optimal video editing requires 1 frame every second. Real-time virtual reality needs up to 30 frames generated per
20 second. The performance improvements needed to satisfy these two industrial applications are speedups of 108,000x for video editing (= 30 hrs./frame x 3600 seconds/hr) and 3,240,000x for virtual reality (= 30 * Video Editing).

 A similar situation exists in high performance
25 Digital Signal Processing. The typical requirement includes processing images, often collected from 2-D and 3-D sensor arrays over time to construct images of the interior of materials including the human body and machine tools.

 These multidimensional signal processing
30 applications construct images from banks of ultra-sound or magnetic imaging sensors. This has similar performance requirements to frame generation. These applications have the goal of resolving features in a reconstruction/simulation of a 3-D or 4-D environment. (Note: 4-D here means a 3-D domain
35 observed/simulated over time.) Feature resolution is a function of input sensor resolution, depth of FFT analysis which can be computationally afforded within a given period of time, control of round-off errors and the accumulation of

those rounding errors through the processing of the data frames.

Fine feature resolution in minimum time lead to performing millions and often billions of arithmetic operations per generated pixel or output data point. The use of floating point arithmetic to provide dynamic range control and flexible rounding error control is quite common. Algorithmic flexibility is a priority, due to the continuing software evolution and the availability of many different applications. These differing applications often require very different software.

The application software development requirements are very consistent. In particular, most applications need numerous programs, mostly written in the procedural computer programming languages, C, C++ and FORTRAN (see references [11]-[18]); and the use of machine level programming is restricted to the most performance critical portions of the programs.

The target algorithms display the following common features: a need for large amounts of memory per processing element, often in the range of 100 MB; a need for very large numbers of arithmetic calculations per output value (pixel, data point, etc.); a need for very large numbers of calculations based upon most if not all input values (pixel, data point, etc.); and relatively little required communication overhead compared to computational capacity.

Support for high resolution graphics has developed over the last 30 years. Preliminary efforts in the 1960's and early_1970's such as seen in reference [40] created graphics computer systems with a minimum of specialized hardware. There was little or no thought at that time to VLSI (Very Large Scale Integration) integrated circuits (ICs).

The support of the graphics industry by semiconductor devices has focused on the following issues:

A. Support of I/O devices, with the support of the screen display device consuming the bulk of the effort.

This has lead to the development of specialized

Integrated Circuits to control the screen. See references [2].

B. Development of high speed micro-processors and Digital Signal Processors.

5 C. Development of high speed and high density memory devices, particularly DRAMs, VRAMs, etc..

D. Special purpose components aimed at real-time image processing and frame generation applications.

10 These efforts have fundamental limitations, as is described below.

A. Display device controllers are limited in that each frame is generated by a fixed execution structure machine within a specific amount of time. Thus, the variation of frame algorithms is necessarily limited.

15 B. High speed micro-processors and DSPs possess great intrinsic algorithmic flexibility and are therefore used in high performance dedicated frame rendering configurations such as the SUN network that generated Toy Story. See reference [1]. The advent of the Intel Pentium™ processors brought the incorporation of all the performance tricks of the RISC (Reduced Instruction Set Computing) community. "Appendix D: An Alternative to RISC: The INTEL 80x86" in reference [30] and "Appendix: A Superscalar 386" in reference [31] provide good references on this. "Appendix C: Survey of RISC Architectures" in reference [30] provides a good overview.

25 However, commercial micro-processor and DSP systems are severely limited by their massive overhead circuitry. In modern super-scalar computers, this overhead circuitry may actually be larger than the arithmetic units. See references [30] and [31] for a discussion of architectural performance/cost tradeoffs.

30 C. High performance memory is necessary but not sufficient to guarantee fast frame generation because it does not generate the data--it simply stores it.

35 D. There have been several special purpose components proposed which incorporate data processing elements tightly coupled on one integrated circuit with high performance memory, often DRAM. However these efforts have

all suffered limitations. The circuits discussed in [32] use fixed point arithmetic engines of very limited precision. The circuits discussed in [32] are performance constrained in floating point execution, and in the handling of programs larger than a single processor's local memory.

The proposed special purpose components are optimized to perform several categories of algorithms. These components include:

D1. Image compression/decompression processors.

These circuits, while important, are very specialized and do not provide a general purpose solution to a variety of algorithms. For example, such engines have tended to be very difficult to efficiently program in higher level procedural languages such as C, C++ and FORTRAN. The requirement of programming them in assembly language implies that such units will not address the general purpose needs for multi-dimensional imaging and graphical frame generation without a large expenditure on software development. See References [24] and [25].

D2. Processors optimized for graphics algorithms such as fractals, Z-buffers, Gouraud shading, etc. These circuits do not permit optimizations for the wide cross-section of approaches that both graphics frame generation and image processing require. See references [26]-[29].

D3. Signal processing pre-processor accelerators such as wavelet and other filters, first pass radix-4, 8 or 16 FFT's, etc. 1-D and 2-D Discrete Cosine Transform engines. These circuits are difficult to program for efficient execution of the wide variety of large scale frame generation tasks.

D4. Multiprocessor image processors. These processors include mixed MIMD and SIMD systems that are ill-suited to general-purpose programming. See reference [24] and [41] to [43].

These processors also include VLIW (Very Long Instruction Word) SIMD ICs such as Chromatic's MPACT ICs. Such ICs again cannot provide the computational flexibility needed to program the large amount of 3-D

animation software used in commercial applications, which require efficient compiler support. See references [34] and [39].

5 D5. Multimedia signal processors. These processors also have various limitations, such as lack of floating point support, lack of wide external data memory interface access bandwidth to large external memories, deficient instruction processing flexibility and data processing versatility, and reliance on vector processors 10 which are inefficient and difficult to program for operations without a very uniform data access mechanism concerning accumulating results. See references [35]- [38].

15 What is needed is a computational engine that avoids the above-described limitations with regard to computation for video frame rendering and DSP tasks.

SUMMARY OF THE INVENTION

20 A circuit is provided which contains memory, logic, arithmetic and control circuitry needed to generate all or part of a frame for use in video processing and animation as well as digital signal and image processing. One or more such circuits are provided on an integrated circuit. A video or 25 image frame generation system is constructed from one or more of these integrated circuits, optionally with additional memory circuitry, to provide exceptional performance in frame production for animation, particularly 3-D and other high performance applications such as medical imaging, virtual 30 reality and real-time scene generation in video games and simulation environments. The circuit(s) are used to process high speed object-oriented graphics related streams such as proposed by MPEG 4, as well as act as a single chip JAVA engine with highly optimized numeric performance.

35 <++++insert claim-mirroring language here++++>

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a block diagram of a basic circuit according to embodiments of the present invention.

FIG. 2 is a block diagram of the array processor of FIG. 1 according to an embodiment of the present invention.

5 FIG. 3 is a block diagram of the array processor of FIG. 1 according to another embodiment of the present invention.

FIG. 4 is a block diagram of the embedded microprocessor of FIG. 1.

10 FIG. 5 is a block diagram of an integrated circuit having two instances of the basic circuit of FIG. 1 with independent external memory interfaces.

FIG. 6 is a block diagram of an integrated circuit having two instances of the basic circuit of FIG. 1 sharing one external memory interface

15 FIG. 7 is a block diagram of an integrated circuit having four instances of the basic circuit of FIG. 1 with independent external memory interfaces

FIG. 8 is a block diagram of an integrated circuit having four instances of the basic circuit of FIG. 1 sharing one external memory interface.

20 FIG. 9 is a block diagram of an integrated circuit having four instances of the basic circuit of FIG. 1 sharing two external memory interfaces.

25 FIG. 10 is a block diagram of an integrated circuit having four instances of the basic circuit of FIG. 1 with two shared external memory interfaces and fully interconnected message ports.

FIG. 11 is a block diagram of an integrated circuit having sixteen instances of the basic circuit of FIG. 1 with four shared memory interfaces.

30 FIG. 12 is a block diagram of an integrated circuit having sixteen instances of the basic circuit of FIG. 1 with two shared memory interfaces.

35 FIG. 13 is a block diagram of a printed circuit board uniting instances of the of the basic circuit of FIG. 1 with their corresponding memory modules.

FIG. 14 is a block diagram of another printed circuit board uniting instances of the of the basic circuit of FIG. 1 and their corresponding memory modules.

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DEFINITIONS

Wire

A wire is a mechanism for sharing the state between multiple nodes of a circuit. The state is a finite alphabet based upon certain physical conditions including but not limited to: electrical voltage, current, phase, spectral decomposition, photonic amplitude. Symbols are the individual elements of an alphabet. Measured value ranges of the relevant physical conditions typically encode symbols. The most commonly used alphabet is the set {0,1}, the binary symbol set. Binary systems using all of the above schemes exist. Other commonly used alphabets include 3 symbol alphabets, e.g., {0,1,2}, multiple binary alphabets, e.g., {00,01,10,11}, etc. There are other alphabets in use. A wire may be embodied, for example, as a strip of metal (e.g., in an integrated circuit or on a circuit board), an optical fiber, or a microwave channel (sometimes referred to as a microchannel).

Wire Bundle

A wire bundle is a collection of one or more wires.

Bus

A bus is a wire bundle possessing a bus protocol. The bus protocol defines communication between circuits connected by the wire bundle. A bus will typically be composed of component wire bundles wherein one or more of the component wire bundles will determine which connected components are receiving and which are transmitting upon one or more of the other component wire bundles.

Floating Point

Floating point notation includes a collection of states representing a numeric entity. The collection includes

sub-collections of states defining the sign, mantissa and exponent of the represented number. Such notations non-exclusively include binary systems including but not limited to IEEE standard floating point and special purpose floating point notations including but not limited to those discussed in the references of this document. A floating point notation non-exclusively includes extensions whereby there are two sub-collections each containing the sign, mantissa and exponent of a number as above. The numeric representation is of an interval wherein the number resides. A floating point notation additionally includes non-binary systems, wherein the mantissa and exponent refer to powers of a number other than 2.

Programmable Finite State Machine

A programmable finite state machine is a machine which includes a state register, possibly one or more additional registers wherein state conditions, quantities, etc. reside, and a mechanism by which the state register, additional registers, external inputs generate the next value for the state register and possible additional registers.

SIMD

A Single Instruction Multiple Datapath architecture executes the same instruction on more than one datapath during the same instruction execution cycle. A typical extension to this basic concept is the incorporation of "status flag bits" associated with each datapath. These flags enable and disable the specific datapath from executing some or all of the globally shared instructions.

SIMD architectures are optimal in situations requiring identical processing of multiple data streams. The inherent synchronization of these data streams produce advantages by frequently simplifying communications control problems. SIMD architectures become inefficient whenever the data processing becomes dissimilar between the datapaths.

SIMD architectures require a relatively small amount of instruction processing overhead cost because there is only

one instruction processing mechanism, shared by the datapaths. The instruction processing mechanism has an instruction fetching mechanism. The datapath collection typically needs only one instruction memory.

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MIMD

A Multiple Instruction Multiple Datapath architecture executes distinct instructions on different datapath units. The fundamental advantage of this approach is flexibility. Any data processing unit can execute its own instruction, independently of the other data processing units. However, this flexibility has added costs. In particular, each data processing unit must possess its own instruction fetching, decoding, and sequencing mechanisms. The instruction fetching mechanism frequently possesses at least a small memory local to the data processor. This local memory is often a cache.

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(Very) Long Instruction Word Processors (VLIW and LIW, respectively)

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A (Very) Long Instruction Word Processor is a class of architectures whereby there is a single instruction processing mechanism which contains a program counter capable of common operations, such as branches on condition codes, and multiple instruction fields that independently control datapath units. In these architectures, the datapath units often are not identical in structure or function.

Array Processor

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An Array Processor is defined as an LIW or VLIW instruction-processing architecture having multiple datapath units arranged into one or more collections. In embodiments of the present invention, as will be described, the datapath collections receive and may act upon a common operand received via a common operand bus having a transmitting unit; each datapath receives one or more additional operands from a memory; each datapath collection contains an instruction memory possessing instruction fields that control the

operation of the program controlled elements within; each datapath unit contains one or more multiplier/accumulators (MACs); and each MAC possesses a multiplicity of accumulating registers.

Multiplier-Accumulator

A Multiplier-Accumulator is an arithmetic circuit simultaneously performing multiplication of two operands and addition (and possibly subtraction) of at least one other operand.

Fast Fourier Transform (FFT)

The fast fourier transform is a highly optimized algorithm for generating the spectrum of a signal. See the relevant chapters of references [11], [12], and [15] for thorough discussions of the various involved topics.

Vector Processor

A vector processor is an architecture designed to operate exclusively on vectors. Typically, a vector processor is deeply pipelined. There is a large literature devoted to vector processing. See references [46]-[53]. Appendix B, "Vector Processors" in reference [30] provides an overview on the subject.

DESCRIPTION OF SPECIFIC EMBODIMENTS

The present invention provides a cost-effective basic circuit which encapsulates memory, logic, arithmetic, and specialized circuitry and controls particularly suited to supporting a broad class of algorithms, especially those used for video frame rendering. Replicating the basic circuit increases the computing capacity, creating the capability to support very high performance requirements.

The distinction between high performance, often multi-dimensional, signal processing and high performance frame rendering graphics is slight. For the duration of this document, the discussion will focus on frame rendering from a

graphics perspective, with commentary added where necessary to delineate the differences in application of the invention.

FIG. 1 is a block diagram of a basic circuit 1 according to embodiments of the present invention. In the basic circuit 1, one or more controllers 2 for external local memory interface(s) provides access to a local external memory (shown in a later figure) associated with the basic circuit 1. Such local external memory is preferably on the order of 100 megabytes or greater (see Toy Story, reference [1]), e.g., to one gigabyte. A Master Memory Interface and Controller (MMIC) 6, also referred to as the "large memory wide interface circuit" 6, controls the flow of data, including instructions, between the external local memory interface(s) 2 and various other components. The MMIC 6 also controls access to an internal local memory 4. The basic circuit 1 also includes a Global External Bus Interface (GEBI) 7, an embedded microprocessor sub-system 8, a DSP (array processor) 9, neighboring circuit communication port(s) 10, special purpose circuitry 11 (e.g., specialized frame generator circuitry, Content-Addressable Memory--CAM, bit code parser, etc.), and wire bundles 3, 5, 12, 13, 14, 15, 16, and 17 which interconnect the circuits as indicated in Figure 1.

The GEBI 7 provides an interface to the external environment. This external bus may be a standard computer bus such as the well-known Peripheral Component Interconnect (PCI), Accelerated Graphics Port (AGP), Universal Serial Bus (USB), IEEE 1394 (formerly, FireWire), or Fiber Channel; or a special purpose bus designed to support communications between external controller-host(s) and a multiplicity of instances of this invention.

The embedded micro-processor sub-system 8 controls operation of the basic circuit 1 and performs computations not targeting the DSP (array processor) 9 or the special-purpose circuitry 11. The micro-processor sub-system 8 is discussed in more detail below.

The DSP (array processor) 9 performs floating point computations. In one embodiment of the present invention, the DSP (array processor) 9 is as shown and discussed in U.S.

Patent Application No. 60/050,396, filed June 20, 1997, incorporated by reference. The DSP (array processor) 9 is discussed in more detail below.

5 The neighboring circuit communication port(s) 10 provide communication between the basic circuit 1 and other instances of the basic circuit 1 in a system. In system applications wherein only one instance of the basic circuit 1 is used, these port(s) 10 are not needed. An exception to the previous sentence exists in a specific embodiment in which
10 some of these port(s) 10 provide communication with other components (not shown) which are not instances of the basic circuit 1 but which nevertheless benefit from highly concurrent transactions with or via the instance of the basic circuit 1.

15 Applications having multiple instances of the basic circuit 1 often need high speed, concurrent communications between the instances of the basic circuit 1. By providing the communication port(s) 10, the basic circuit 1 reduces a potential bottleneck in the GEBI 7. In a specific embodiment,
20 the communication port(s) 10 provide dedicated communication between exactly two instances; therefore, the protocols used on each port may be much simpler than, e.g., the bus protocol used in the external bus interface 7.

In general, standard methods are used for inter-
25 instance communication. For example, various communication schemes based on messaging protocols, which are well documented in the art, may be used. Similarly, any of several "semaphore" systems, or handshaking systems, may be used to provide the ability to synchronize and control Concurrent
30 Sequential Processes (CSP) operating upon instances which are not proximate.

Special purpose circuitry 11 exist in various embodiments to provide performance enhancement for otherwise extremely complex or time consuming operations essential to an
35 application. Examples of such circuitry include, but are not limited to: a frame generator for accelerating Z-buffer operations, triangular fills, "BitBlts" and surface texturing; a content addressable memory (CAM) for accelerating pattern

matching for fractal compression or transforming a compressed token into a standard handle pointing into a hash table, for instance; and a bit code parser for decoding the command and data headers for highly compressed communications schemes such as MPEG (Moving Pictures Experts Group) and languages such as Java™, which is a trademark of Sun Microsystems.

Internal memory bank(s) 4 contain one or more banks of random access memory (RAM) arrays. These memories are economical dynamic random access memory (DRAM) in embodiments of the invention, but other types of memories may also be used. In a preferred embodiment, one to 32 megabytes (MBs) of total memory, organized in a wide configuration, are provided. Widths of up to 1024 bits (1K bits) are contemplated. Widths above 64 bits are considered to be "wide." Preferred configurations for these memories include but are not limited to:

32K by 64, by 128, by 256, by 512 and by 1K bits;
64K by 64, by 128, by 256, by 512 and by 1K bits;
128K by 64, by 128, by 256, by 512 and by 1K bits;
256K by 64, by 128, by 256, by 512 and by 1K bits;
Etc.

Note that configurations providing access to data lengths other than powers of 2, such as 72, can have advantages. Such configurations support error detection and correction schemes implemented with added, standard logic incorporated in the MMIC 6.

The MMIC 6 (master memory interface and control) is a digital logic circuit which supports a number of functions. If the internal memory banks 4 are DRAM, or require refreshing as does DRAM, then the MMIC 6 automatically refreshes the internal RAM banks 4. The MMIC 6 allows and controls access to the internal RAM banks 4 for reading and writing by the GEBI 7, the embedded microprocessor 8, the DSP (array processor) 9, and, potentially, by instances of the neighboring circuit communications ports 10 and by the special purpose circuitry 11. The MMIC 6 also allows and controls access to the external local memory interface(s) 2 by the GEBI 7, the embedded microprocessor 8, the DSP (array processor) 9,

and potentially by instances of the neighboring circuit communications ports 10 and by the special purpose circuitry 11.

In preferred embodiments of the invention, the MMIC 6 includes an Finite State Machine (FSM) to control the data and instruction flow by accepting requests from the modules 7, 8, 9, 10, and 11 for data and/or instructions in the external local memory. The MMIC 6 satisfies them based on a decision algorithm encoded in the FSM. FSMs for data/instruction flow control are well known.

In a preferred embodiment of the invention, separate instruction and data streams are maintained for each of the embedded microprocessor 8, the DSP (array processor) 9, and the special-purpose circuitry 11. These instruction and data streams would typically reside on the external local memory, after having been loaded therein, during program initialization and operation, from the GEBI 7. These instruction and data streams would typically be produced by one or more compilers according to known compiler technology, and may incorporate some amount of handshaking for coordination according to known methods.

In addition to the MMIC 6, the embedded microprocessor 8 and the GEBI 7 provide direction for controlling data/instruction flow in a manner known in the art. For example, the microprocessor 8 can preemptively seize control of the FSM for, e.g., error control, initialization, and capture of bus error transactions on the GEBI 7.

The controller 2 for the external local memory interface(s), or ELMI(s) 2, provide support for external timing and interface conventions to access one or more kinds of external IC memories. For example, the ELMI(s) 2 provide read and write access to RAM and read access to non-volatile memories. If some or all external memory is DRAM-related (see Chapters 6 and 7 in reference [54], then the ELMI(s) 2 support automatic memory refresh. Optimally, the ELMI(s) 2 provide queuing of access requests during refresh. The ELMI(s) 2 optionally also provide queuing of access requests during write, erase and other potentially slow operations.

In embodiments in which at least some of the external memory is programmable and non-volatile (see Chapters 10, 11 and 12 in reference [54]), the ELMI(s) 2 provide writing of specific words and, as appropriate, erasing of blocks of words. Optionally, the ELMI(s) 2 provide additional functions known in the art, such as erase-suspend for non-volatile memory operations, in order to provide advantages in certain applications.

Although not specifically shown in FIG. 1, the basic circuit 1 in alternate embodiments include one or more analog interface components, such as analog-to-digital (A/D) converters, and digital-to-analog (D/A) converters, Voltage Controlled Oscillators (VCOs), etc., and their corresponding wire bundles.

Additional secondary support circuitry in alternate embodiments include, but are not limited to, internal clock multipliers, Phase Locked Loops (PLLs), clock distribution networks, built in self test (BIST) circuitry, boundary scan path(s), etc., which are known in the relevant art.

The basic circuit 1 has a design which is optimized in many ways to provide a high performance computation engine for frame rendering and similar tasks. Significantly, the embedded microprocessor 8, the DSP (array processor) 9, and special-purpose circuitry 11 are provided with the circuit resources to process their individual instructions and data concurrently and with a minimum of stalling for lack of data or instructions. This efficiency arises for example from the overall design and from the design of the individual modules, as described above and below. For example, the wire bundle 13 reduces the bandwidth overhead on the main bus interface (MMIC 6, and wire bundles 12, 14, 15, 16, 17) by providing a dedicated path for interactions, e.g., control, between the global external bus 7 and the embedded microprocessor 8 that is independent of the primary flow transactions on the main bus interface. In this way, the bandwidth of the main bus interface is conserved.

In a preferred embodiment, the basic circuit 1 is implemented as an integrated circuit (IC). Importantly, the

basic circuit 1 can be implemented using relatively low amounts of IC surface area due to its design. Also, the architecture is simple and flexible enough to permit compilers to efficiently target its computation units, especially the microprocessor and the array processor.

FIG. 2 is a block diagram of the array processor 9 of FIG. 1 according to an embodiment of the present invention. As will be clear from the discussion below, the array processor 9 is capable of performing calculations that cannot be efficiently processed in parallel using prior-art vector processing techniques, as discussed in the cited references.

The calculations include, for example, calculations requiring several relatively short vectors. For example, in calculating complex valued functions such as $X = (az+b)/(cz+d)$, wherein a , b , c , d , and z are all complex floating point numbers. As is well-known, these calculations and similar calculations are common in frame rendering. To calculate the function, a_0 , b_0 , c_0 , d_0 , z_0 and X_0 are defined as the real components and correspondingly, a_1 , b_1 , c_1 , d_1 , z_1 and X_1 are defined as the imaginary components. The calculation prior to entry into a floating point division circuit proceeds in two multiply-accumulate passes. In the first pass, the following are calculated:

$$A_0 = a_0 * z_0 - a_1 * z_1 + b_0$$

$$A_1 = a_0 * z_1 + a_1 * z_0 + b_1$$

$$B_0 = c_0 * z_0 - c_1 * z_1 + d_0$$

$$B_1 = c_0 * z_1 + c_1 * z_0 + d_1$$

In the second pass, the results of B_0 and B_1 are fed back into multiplier-accumulators (discussed later) as shared operands to generate:

$$C_0 = A_0 * B_0 - A_1 * B_1$$

$$C_1 = A_1 * B_0 + A_0 * B_1$$

$$D = B_0 * B_0 + B_1 * B_1$$

Finally, the division operations are performed:

$$X_0 = C_0 / D$$

$$X_1 = C_1 / D$$

According to the embodiment of FIG. 2, an array processor interface circuit (APIC) 965 controls the requesting and receiving of instructions and data from the MMIC 6 and the sending of data to the MMIC 6. The array processor 9 in this
5 embodiment has a single collection 970 of multiple datapath processing units 900. The datapath processing units 900 are also referred to simply as datapaths 900. The collection 970 forms an Arithmetic Processing Unit (APU) 970.

Within the APU 970, an internal floating point
10 notation is used. This internal notation may or may not be the same as the floating point notation(s) used externally. In general, the APU 970 is adapted to expect at least a standard external notation, e.g., standard IEEE floating point notation. In a preferred embodiment, the floating point
15 notation used is a simplified notation that does not include the exceptional cases of, e.g., standard IEEE floating point notation. Using the simplified notation enables greater internal efficiency, e.g., with regard to circuit size, by avoiding the complexity of the exceptional cases. Using the
20 simplified notation is practical because the exceptional cases are typically not of great relevance in frame rendering and DSP applications.

The APU 970 includes a shared operand circuit (SOC) 910 which acts as a multiplier input circuit. Optionally, the
25 SOC 910 includes a RAM circuit having address controls that determine whether the RAM may be used as an operand cache or a first-in-first-out (FIFO) queue. A first sub-circuit (not shown in the figure) within the SOC 910 includes a multiplicity of input registers for accepting input and
30 capturing the state of the wire bundle 902. The SOC 910 contains a second sub-circuit (not shown) coupled to the registers within the first sub-circuit. The second sub-circuit includes an integer Arithmetic Logic Unit (ALU) (not shown). The second sub-circuit performs fixed point
35 add/subtracts (in the ALU) on selected fields of the state of the wire bundle 902 from the registers. The second sub-circuit also converts the fixed point result of the add/subtract operation or of the selected fields of the input

registers into an internal floating point notation according to known conversion algorithms. Therefore, the second sub-circuit is said to contain a floating point conversion unit (not shown).

5 The APU 970 also includes two or more Multiplier/ACcumulators (MACs) 900 as the datapath processing units 900. MACs are well-known in the relevant art. Each MAC 900 is coupled to wire bundle 906 for receiving a shared operand from the SOC 910. Each MAC 900 is also coupled to a
10 corresponding Local Data Store 920. In general, there are as many local data memory circuits 920 as MACs 900.

 During operation, each MAC 900 receives 3 numbers X, Y and Z in some numeric format, wherein X is the shared operand received via wire bundle 906, and Y and Z are received
15 from the local data store 920 via wire bundle 909.

 Each MAC 900 possesses two or more registers, preferably at least four. Each MAC 900 can perform a multiplication and an add/subtract in each clock cycle to thereby generate $XY+Z$ or $XY-Z$ from values of X, Y and Z
20 received in the (possibly) current or predecessor clock cycles. Each MAC 900 conditionally stores the generated result in one of its registers.

 The APU 970 further includes a Shared Output and Feedback Interface (SOFI) 940. The SOFI 940 contains a
25 floating point conversion unit (not shown) that is adapted using standard techniques to convert the internal numeric format of a wire bundle (907) to the requisite floating point (e.g., IEEE floating point) or fixed point notation needed externally. Of course, in embodiments in which the internal
30 floating point representation is identical to the external representation, then that particular conversion need not be performed. The SOFI 940 controls the transmission of the results of such conversions upon a wide bus 901 to the APIC 965. In a particular embodiment, the SOFI 940 also
35 temporarily stores such results as necessary prior to transmission.

 The data memory 920 has a corresponding address generator (in, e.g., module 950, discussed below) for

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memory circuit (920) or the state of another MAC's register provides the other two operands.

5 The array processor 9 according to the present invention enables types of computations to be performed which could not be efficiently performed using, e.g., vector
processors. For example, in the calculation of several Discrete Wavelet Transform Filters (DWTs) it is frequently
10 necessary to share several different scalars across several sub-components of a vector. Vector processors typically required as many cycles to perform this task as the number of
scalars to be shared. In these DWTs, every even input affects all the filter outputs, and the odd inputs affect only
15 half the filter outputs. Processing four inputs in this manner forces the limitation that the odd entries cannot be concurrently processed using the vector processor approach. In the array processor 9, however, these problems are
minimized, for example because it can send two (or more) odd-entry scalar elements to different components of a vector. Radix 2 FFTs present both the sum and difference to differing
20 components of a vector. The present invention, by presenting these in parallel to the respective components of the vector achieves the result in one cycle, rather than two cycles per pair of elements required by vector processors.

FIG. 3 is a block diagram of the array processor 9
25 of FIG. 1 according to another embodiment of the present invention. As shown in FIG. 3, the array processor 9 has two APU 970. This configuration provides for added concurrency for applications in which floating point calculations are
expected to be especially plentiful in relation to other
30 calculations to be performed by other modules, e.g., the embedded microprocessor. In further embodiments, the number of APUs 970 in the basic circuit 1 can be increased beyond two.

35 The array processor 9 according to FIG. 3 is used in a preferred embodiment in which (referring to FIG. 1) the basic circuit 1 is streamlined to include, in addition to the array processor 9 according to FIG. 3, the GEBI 7, the ELMI(s) 2, the embedded microprocessor sub-system 8, and neighboring

circuit communication port(s) 10, as necessary, but no additional special purpose circuitry 11, no memory banks 4, and therefore a master interface and control (MIC) 6 which omits the memory controller of the MMIC 6.

5 FIG. 4 is a block diagram of the embedded microprocessor subsystem 8 of FIG. 1. Embedded microprocessors are well-known in the relevant art. As shown in FIG. 4, the embedded micro-processor sub-system 8 includes micro-processor(s) 800. The microprocessor 800 can be
10 implemented as a byte-code machine such as a Java or MPEG-4 engine, a Programmable Finite State Machine (PFSM), or a RISC engine, preferably a 16 bit instruction set RISC with a 32 bit data path, such as the ARM7TDMI (see reference [56]) or the MIPS16 (see reference [55]).

15 The embedded micro-processor sub-system 8 also includes an optional local cache 810, preferably 2-4 way interleaved with at least 64 pages and a total memory of at least 1K words of memory. Typically, the cache memory 810 is organized as, e.g., 32 bit words. The cache memory 810 may
20 contain two component caches, one for instructions and one for data.

 The embedded microprocessor subsystem 8 also includes additional optional local storage, such as a RAM 820 or a ROM 830, as is known in the relevant art. The ROM 830
25 may contain, e.g., initialization information for the microprocessor subsystem 8 and/or for the basic circuit 1.

 In a preferred embodiment, the microprocessor(s) 800 provides a two version instruction set: one version being 16 bits in length, which contains the most common instructions
30 used by code generated with compiler technology; and the other version being 32 bits in length. Such microprocessors are known in the relevant art. The advantage of such microprocessors is that most of the generated program code will be in the 16 bit format. In each microprocessor 800,
35 each instruction fetch of 32 bits or more can provide the next 1 to 3 instructions without recourse to further instruction memory accesses.

The basic circuit 1 and array processor 9, as discussed herein, reveal an architecture, or class, of circuitry which has a number of notable advantages.

One such advantage is that the circuit 1 possesses
5 very high levels of efficiency in executing specific computationally intensive algorithms in an environment compared to the performance of such algorithms on comparable sized printed circuit boards using microprocessors or conventional DSPs.

10 In general, the basic circuit 1 has a lower requirement for circuit size compared to other mechanisms available to achieve the same results. Therefore, the basic circuit 1 is cheaper than other mechanisms for achieving the same results. One factor in the array processor 9's low
15 circuit size requirement is that it does not directly implement the division operation, which is actually not very common in a great number of frame rendering and DSP algorithms of interest. In embodiments of the array processor 9 in which the MACs are configured to support only single-precision
20 arithmetic, as is typically sufficient for a large class of frame rendering and DSP applications, the array processor 9's circuit size requirement is substantially further reduced.

The architecture of the array processor 9 provides a "front end" of fixed point addition/subtraction followed by
25 floating point conversion (in, e.g., SOC 910), then multiplication and accumulation (in MACs 900). This "front end" can perform preliminary operations involved with symmetric, anti-symmetric FIRs, and some low radix FFT calculations. These operations are extremely useful in
30 practical DSP applications wherein the data is often received in a fixed point version from sampling circuitry which typically generate between 8 and 16 bits of fixed point precision.

Another advantage of the array processor 9 relates
35 to the general phenomenon of accumulating rounding errors. It is very important that DSP algorithms maintain the precision of arithmetic results. For efficiency, many prior DSP processors use algorithms that perform fixed-point arithmetic.

Such fixed-point arithmetic requires a great deal of care in managing rounding errors to maintain precision. In contrast, the array processor 9 is able to efficiently perform floating point computations. Floating point computations have the advantage of providing much better dynamic range, while being considerably easier to program for the same precision of results.

It is interesting to examine the capabilities of a specific, example embodiment of the array processor 9. In the example embodiment, the array processor 9 (according to FIG. 3) receives, in its APIC 965, at least 128 bits from the MMIC 6. The SOC 910 of each APU 970 can simultaneously receive at least 64 bits (preferably 128 bits). The SOC 910 can decompose the received data into fixed 8 bit or 16 bit integer fields. The SOC 910 can add or subtract these fields in collections of up to 4 simultaneously. The configuration of this example embodiment can achieve extremely high performance in computing radix-4 FFTs, among other computations.

In the example embodiment, the array processor subsystem 9 has an internal clock rate of 200 megahertz (MHz). The following operations can be performed in every clock cycle: four single precision floating point multiplies and 4 single precision floating point additions; an integer/fixed point add/subtract operation, integer/fixed point to floating point scaled conversion; and floating point to fixed point scaled conversion. In the example embodiment, the local data stores 920 are two-way interleaved to support concurrent loading from data received from accesses via the MMIC 6 while fetching the Y and Z operands for the corresponding MAC 900.

In the example embodiment, a communications scheme is embodied in the implementation of the GEBI 7, the MMIC 6, the embedded micro-processor sub-system 8, the ELMI(s) 2, and the array processor 9's APIC 965, using standard techniques, to permit the array processor 9 to stay fully active on the order of 75% of the time for the types of frame rendering and DSP applications envisioned. This performance assumption is reasonable based upon the locality of the data to the basic circuit 1 and to its internal array processor 9.

The resulting performance of the example embodiment, given the above assumptions would be one to three gigaflops (billion floating point operations per second) for many DSP and specific frame rendering algorithms.

5 Assuming that the basic circuit 1 is implemented in a standard IC package such as 176-pin TQFP (Thin Quad Flat Pack), then each IC would take up roughly one square inch of printed circuit board space. Thus, an embodiment of the present invention can be implemented as a PCI bus card capable
10 of holding up to 32 of these ICs, thereby delivering roughly 16 times the performance of a Silicon Graphics Workstation (see Toy Story, reference [1]) at a fraction of the cost.

 The present invention is particularly suited for use in applications involving Java (see references [64]-[65]) and
15 interactive audio-video languages such as MPEG-4 (see references [57] to [63]). The MPEG-4 standards activity is developing an environment where a wide variety of algorithms can run on customer targeted hardware. Java is essentially machine independent in its definition and possesses the
20 semantic capability to create and invoke very complex and computationally expensive algorithms. The present invention provides high performance support of network appliances.

25

Supplemental Description of Some Embodiment(s)

Some embodiments of the present invention might be supplementally described in a stylized, outline form as an integrated circuit including:

30 ... one large memory wide interface circuit wherein the large memory may or may not be located within the integrated circuit wherein the large memory wide interface circuit is connected to the large memory by a bus B0 comprising a wire bundle D0 wherein:

35 bi-directional transceivers within the large memory wide interface circuit connect the wire bundle D0 of said connecting bus B0, providing the transfer of data between the large memory wide interface circuit and the large memory;

one or more data processing circuits including:
either programmable finite state machine (PFSM)
or micro-processor; and

5 a data processor interface circuit to the large
memory wide interface wherein the data processor circuit
is connected to the large memory wide interface circuit
by a bus B1 wherein both circuits comprise:

bi-directional transceivers connect a wire
bundle component D1 of said connecting bus B1; and
10 local memory circuitry to provide the
ability to store the asserted and/or sensed state of
said connecting component wire bundle D1 of said
connecting bus B1 in said local memory circuitry so
as to retain the state information after the state
15 may no longer be asserted and therefore sensed upon
said connecting component wire bundle D1 of said
connecting bus B1;

wherein the signal state of wire bundle D1
of said bus B1 contains some or all of the signal
20 state of D0 translated forward or backward in time,
i.e. a mechanism whereby data may be transferred to
or from wire bundle D0 of said bus B0;

one or more array processors each including an array
processor interface circuit to the large memory wide interface
25 circuit, a shared operand input circuit, a multiplicity of
multiplier/accumulators, and a shared multiplier output
circuit and an instruction decoder circuit wherein:

the array processor interface circuit
connection to the large memory wide interface circuit
30 comprises of a bus B2 wherein both the interface circuit
and the large memory wide interface circuit includes:

bi-directional transceivers connected to a
connecting wire bundle component D2 of said
connecting bus B2; and

35 local memory circuitry to provide the
ability to store the asserted and/or sensed state of
said connecting component wire bundle D2 of said
connecting bus B2 in said local memory circuitry so

as to retain the state information after the state may no longer be asserted and therefore sensed upon said connecting component wire bundle of said connecting bus B2;

5 wherein the signal state of wire bundle D2 of said bus B2 contains some or all of the signal state of D0 translated forward or backward in time, i.e. a mechanism whereby data may be transferred to or from wire bundle D0 of said bus B0;

10 the shared operand input circuit is connected to the array processor interface circuit by a bus B3 and additionally, the shared operand input circuit is connected to the shared multiplier output circuit and to the local data memory circuits associated with each multiplier/accumulator by a bus B4 wherein:

15 the shared operand input circuit receives some or all of the state information of wire bundle; each multiplier-accumulator comprising the multiplication and addition mechanism, plus two independently addressable Random Access Memories wherein:

20 the multiplication and addition mechanism shares one multiplier input and is provided two other inputs from two independently addressable random access memories which may or may not be read only memories;

25 each of the Random Access Memory address and control wire bundles are components of the control wire bundle (CWB);

30 the multiplication and addition mechanism possesses one output driver to a wire bundle MO which is shared the multiplier-accumulators and the multiplier output circuit; and

 each output driver is controlled by a wire bundle component of the control wire bundle CWB; and

35 the multiplier output circuit comprising the MO wire bundle interface, the multiplier output memory circuit and the multiplier output interface wherein:

the MO wire bundle interface comprises
input circuitry connected to the MO wire bundle;
the multiplier output circuit is connected
to the MO wire bundle interface circuitry's input
circuitry in such a manner as to provide data to be
stored in the memory circuitry; and
the memory output circuitry is connected
to the multiplier output interface whereby the state
of the memory circuitry can be output from the
memory output interface onto either a component wire
bundle or the entire bus B3.

In an embodiment, the bus B0 additionally includes
component wire bundles D0A and D0C wherein:

output drivers within the large memory wide
interface circuit connect the wire bundle D0A of said
connecting bus B0, providing the address signals required
to access the large memory data; and

output drivers within the large memory wide
interface circuit connect the wire bundle D0C of said
connecting bus B0, providing the control signals required
to access the large memory data.

In an alternative embodiment, the bus B0
additionally includes a component wire bundle D0F wherein:

input drivers within the large memory wide
interface circuit connect the wire bundle D0F of said
connecting bus B0, providing the feedback signals used to
communication the status of the large memory data access.

In an embodiment, at least one of the communications
interfaces to external circuitry provides a communications
interface to a bus in which the claimed circuit acts as a bus
master.

In an embodiment, at least one of the communications interfaces to external circuitry provides a communications interface to a bus in which the claimed circuit acts as a bus slave.

5

FIGS. 5 through 12 illustrate using the invention to provide near linear speedup to video frame generation tasks and other mostly parallel calculations. As the level of integration grows, there are significant advantages to clustering the external memory interface communication paths into a shared external memory interface. Each external memory interface places a significant economic burden on the production cost by adding many pins to each IC. This increasingly affects not only die size but also thermal dissipation and power consumption. Sharing an external memory interface in this manner economically optimizes communications bandwidth with regards to manufacturing costs.

FIG. 5 is a block diagram of an integrated circuit having two instances of the basic circuit of FIG. 1 with independent external memory interfaces.

FIG. 6 is a block diagram of an integrated circuit having two instances of the basic circuit of FIG. 1 sharing one external memory interface

FIG. 7 is a block diagram of an integrated circuit having four instances of the basic circuit of FIG. 1 with independent external memory interfaces

FIG. 8 is a block diagram of an integrated circuit having four instances of the basic circuit of FIG. 1 sharing one external memory interface.

FIG. 9 is a block diagram of an integrated circuit having four instances of the basic circuit of FIG. 1 sharing two external memory interfaces.

FIG. 10 is a block diagram of an integrated circuit having four instances of the basic circuit of FIG. 1 with two shared external memory interfaces and fully interconnected message ports.

FIG. 11 is a block diagram of an integrated circuit having sixteen instances of the basic circuit of FIG. 1 with four shared memory interfaces.

5 FIG. 12 is a block diagram of an integrated circuit having sixteen instances of the basic circuit of FIG. 1 with two shared memory interfaces.

FIG. 13 is a block diagram of a printed circuit board uniting instances of the of the basic circuit of FIG. 1 with their corresponding memory modules.

10 FIG. 14 is a block diagram of another printed circuit board uniting instances of the of the basic circuit of FIG. 1 and their corresponding memory modules.

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35

WHAT IS CLAIMED IS:

1 1. An integrated circuit, the integrated circuit
2 during operation operating with memory, the integrated circuit
3 comprising:
4 an interface circuit configured to control access to
5 said memory, the interface circuit coupled to said memory;
6 an embedded processor configured to control the
7 integrated circuit, the embedded processor coupled to said
8 interface circuit to receive information therefrom;
9 an array processor for performing arithmetic
10 calculations, the array processor coupled to said interface
11 circuit to receive information therefrom.

1 2. The integrated circuit according to claim 1
2 wherein said array processor comprises:
3 a plurality of multiply/accumulators; and
4 a shared operand circuit coupled to provide a shared
5 operand to at least two of said plurality of
6 multiplier/accumulators.

1 3. The integrated circuit according to claim 1
2 wherein said interface circuit includes a wire bundle for
3 providing wide access.

1 4. The integrated circuit according to claim 3
2 wherein said wire bundle comprises at least 256 wires.

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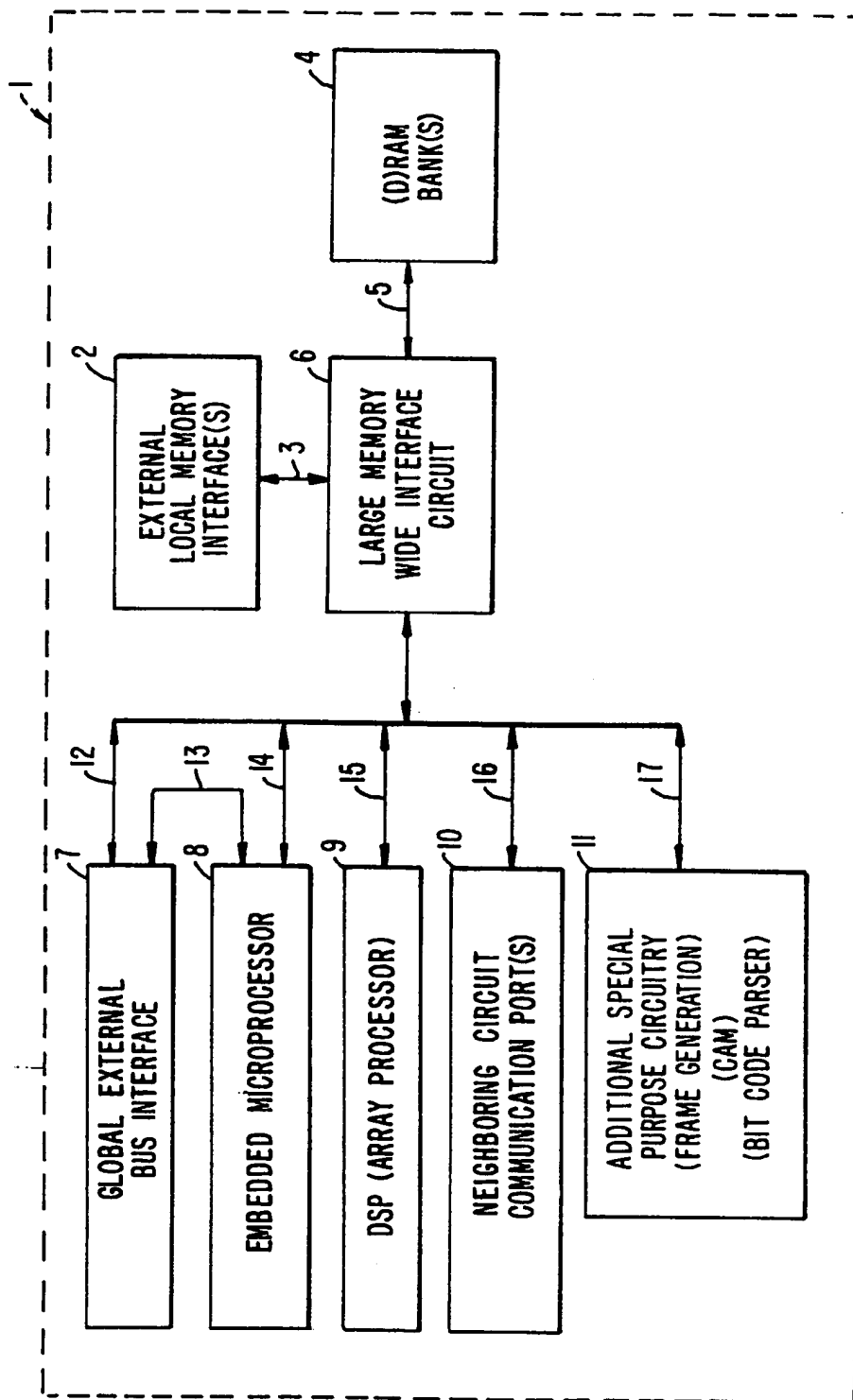
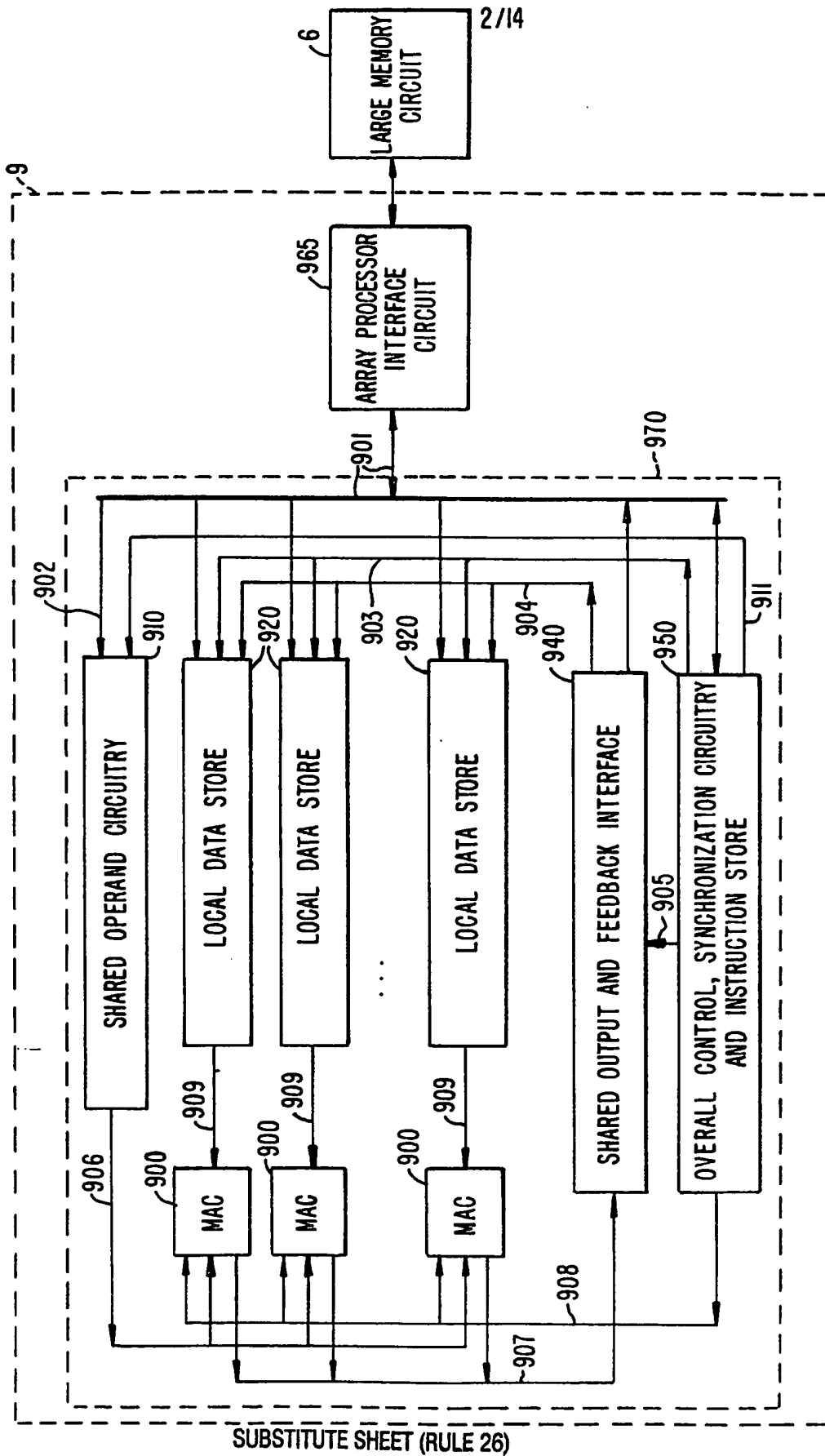


FIG. 1.



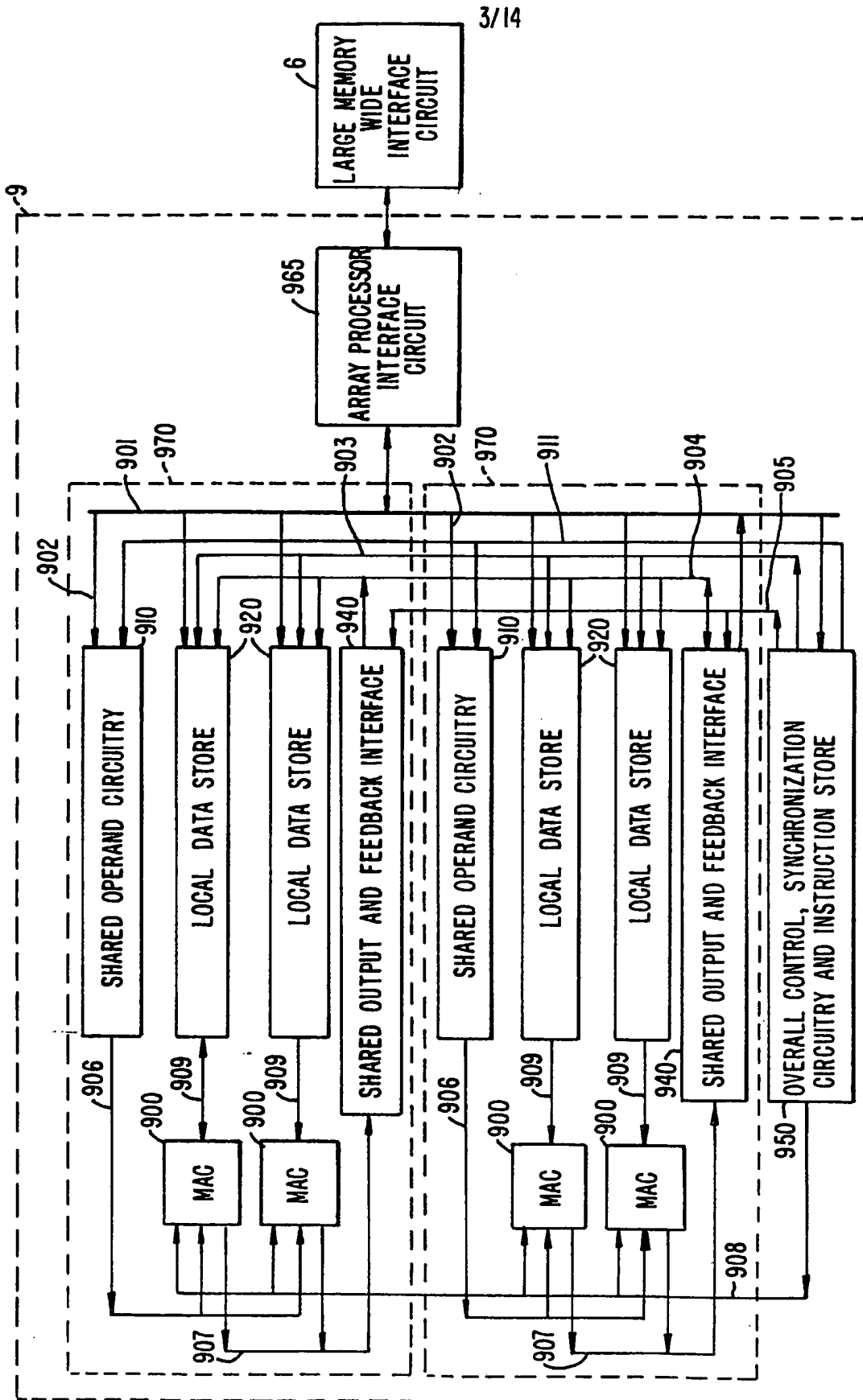


FIG. 3.

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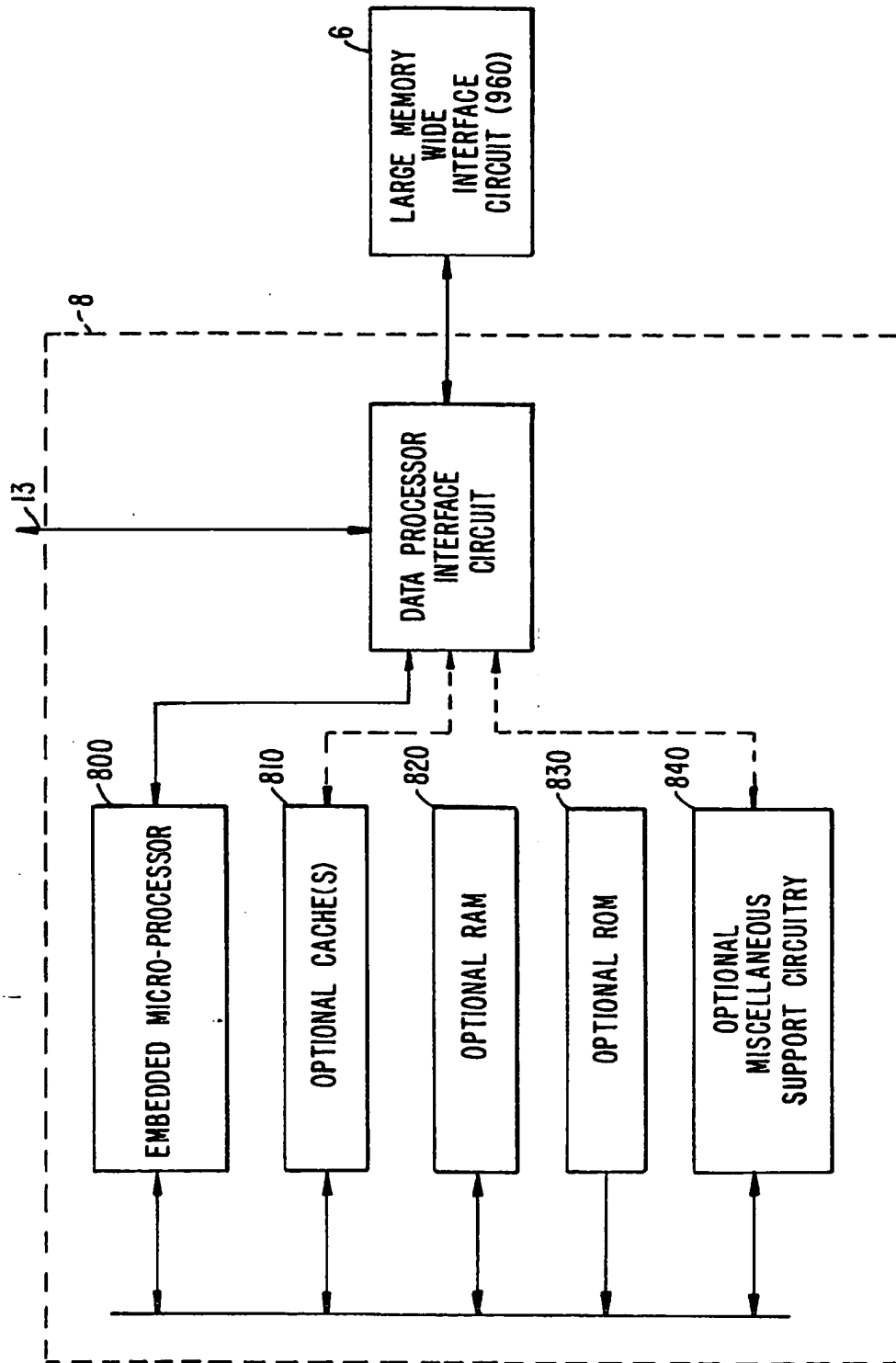


FIG. 4.

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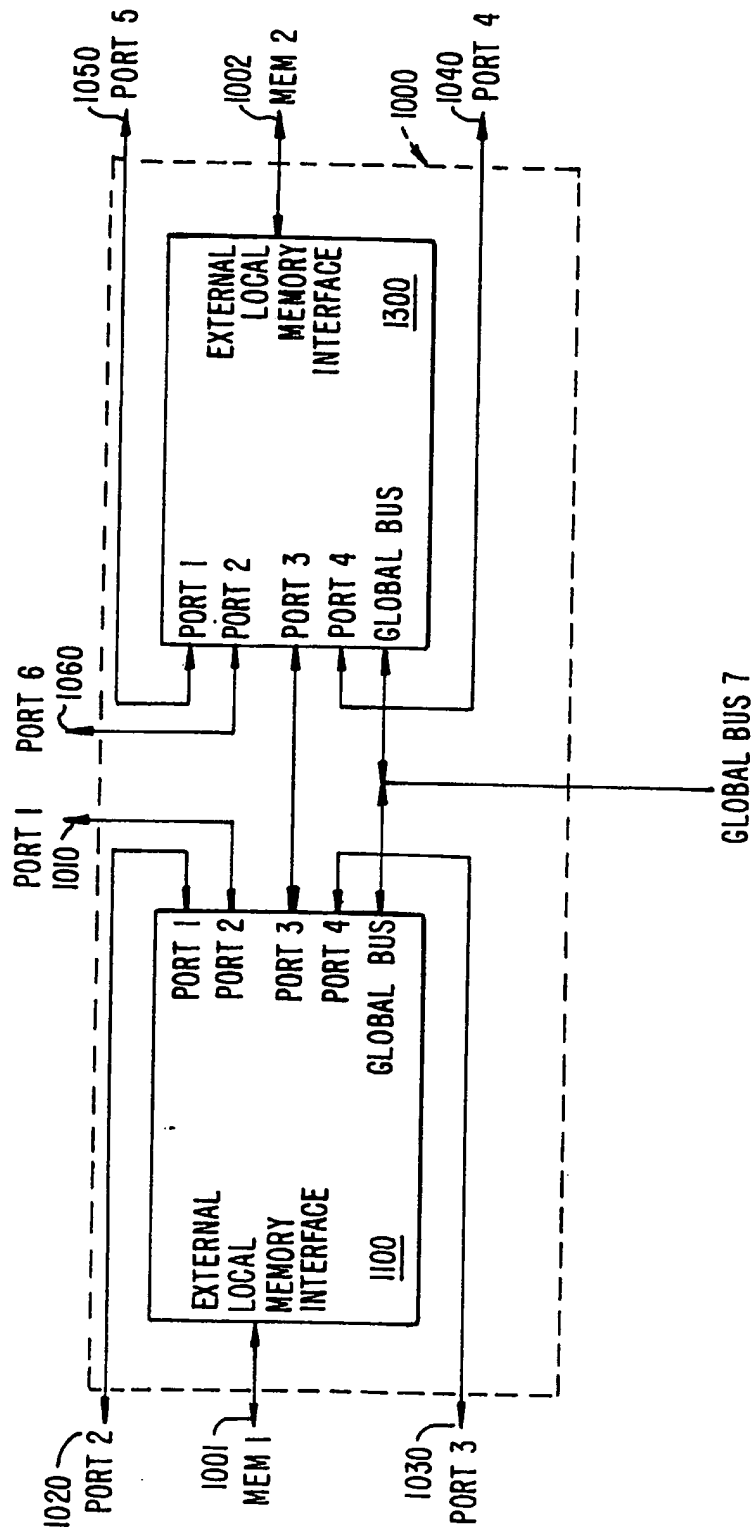
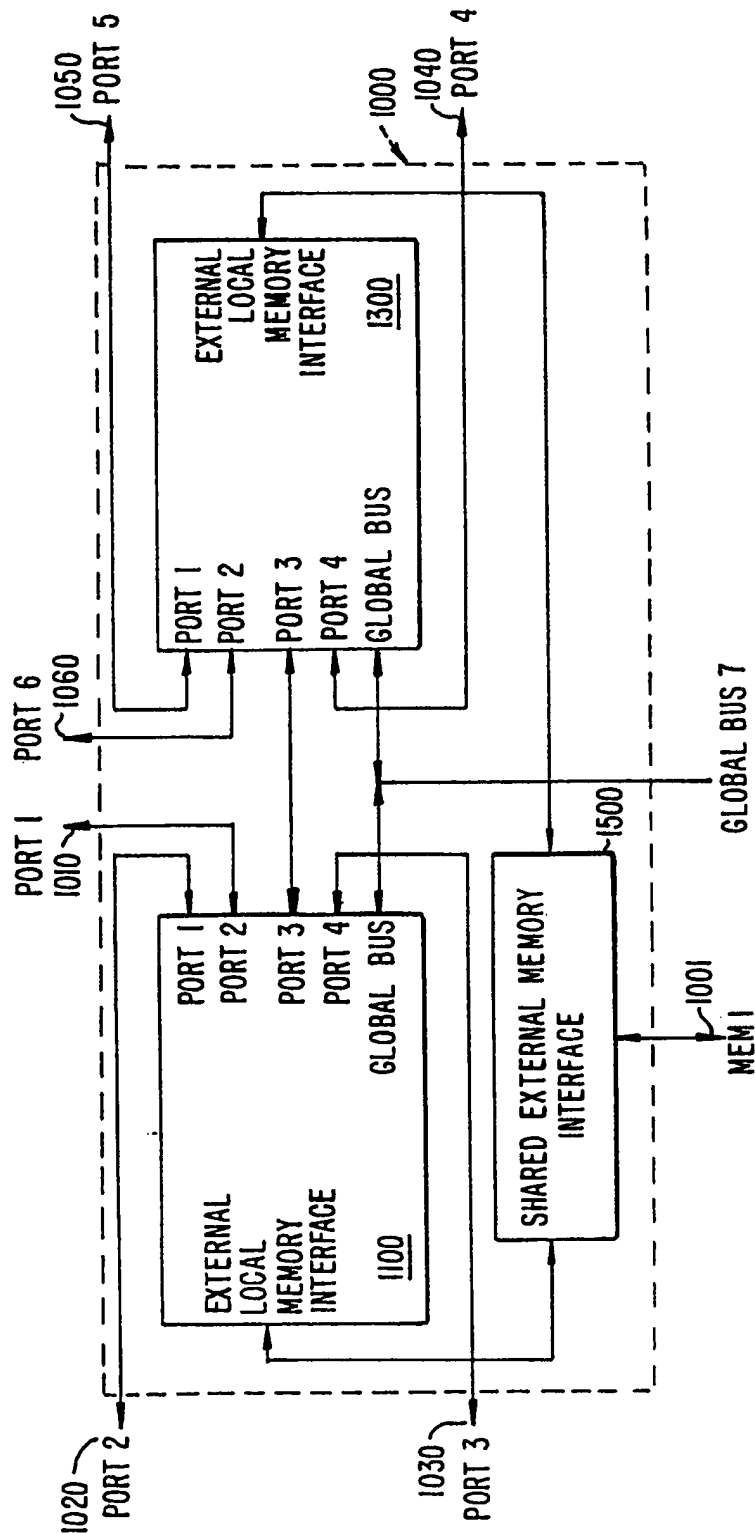


FIG. 5.

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SUBSTITUTE SHEET (RULE 26)

FIG. 6.

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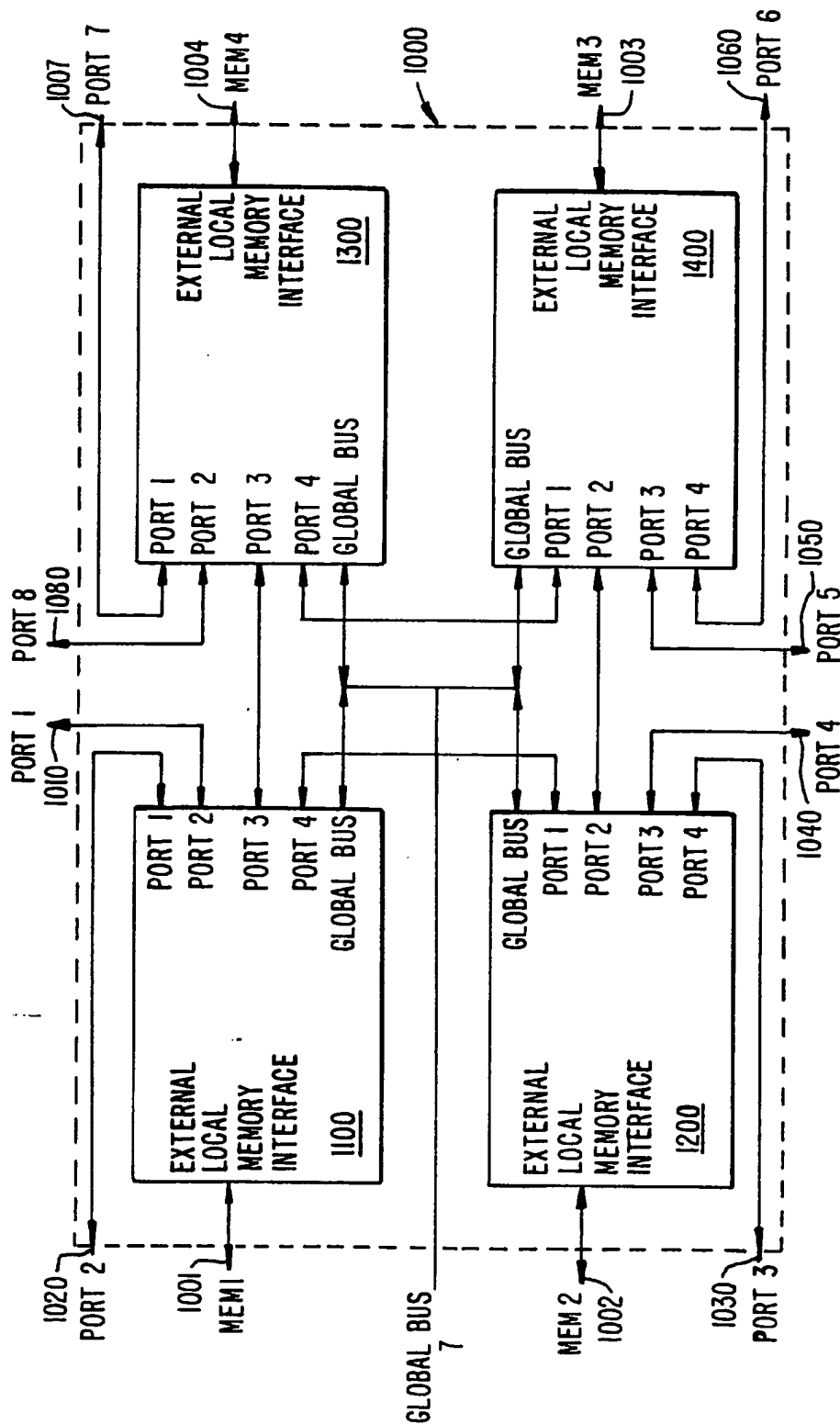


FIG. 7.

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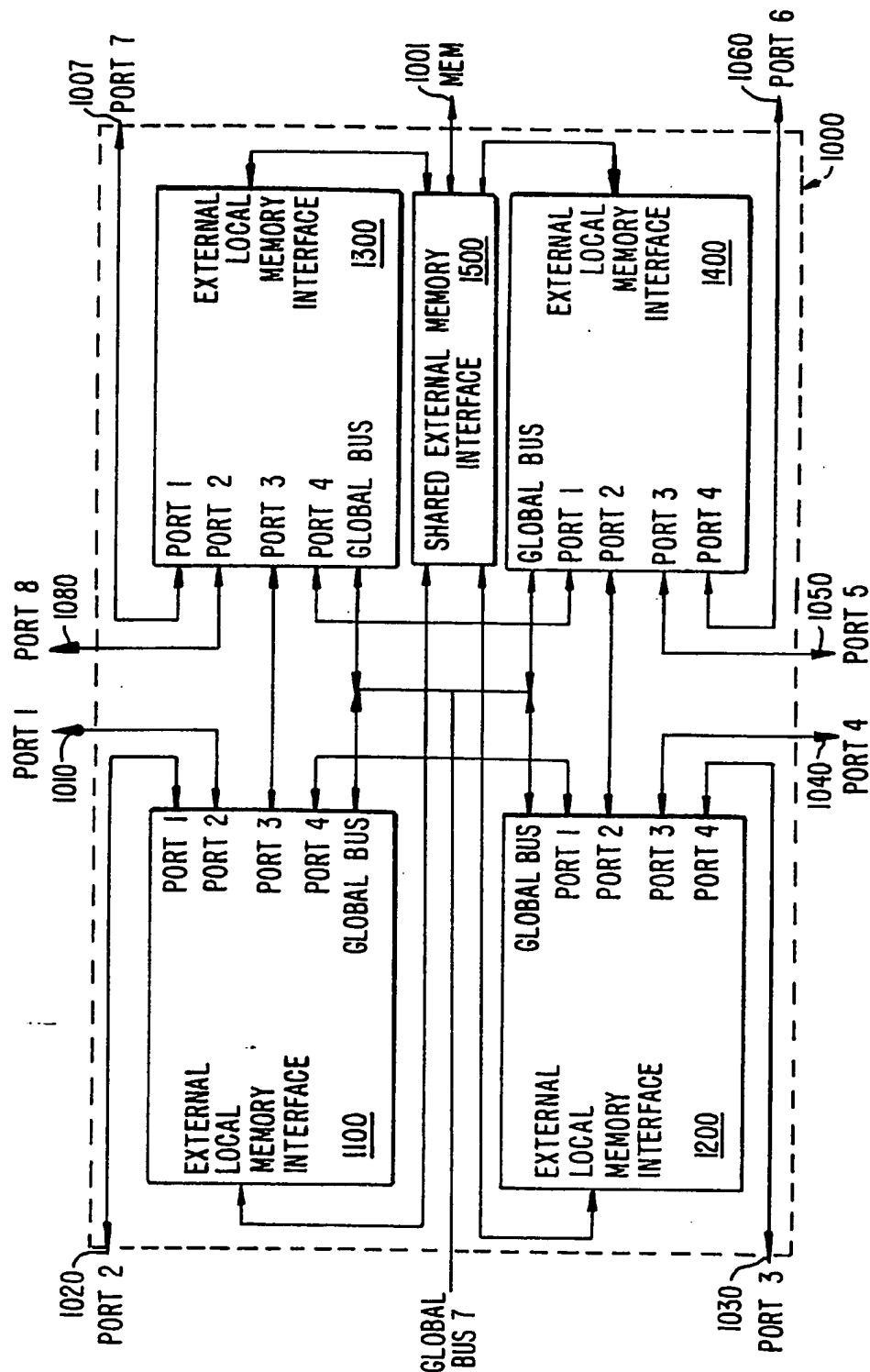


FIG. 8.

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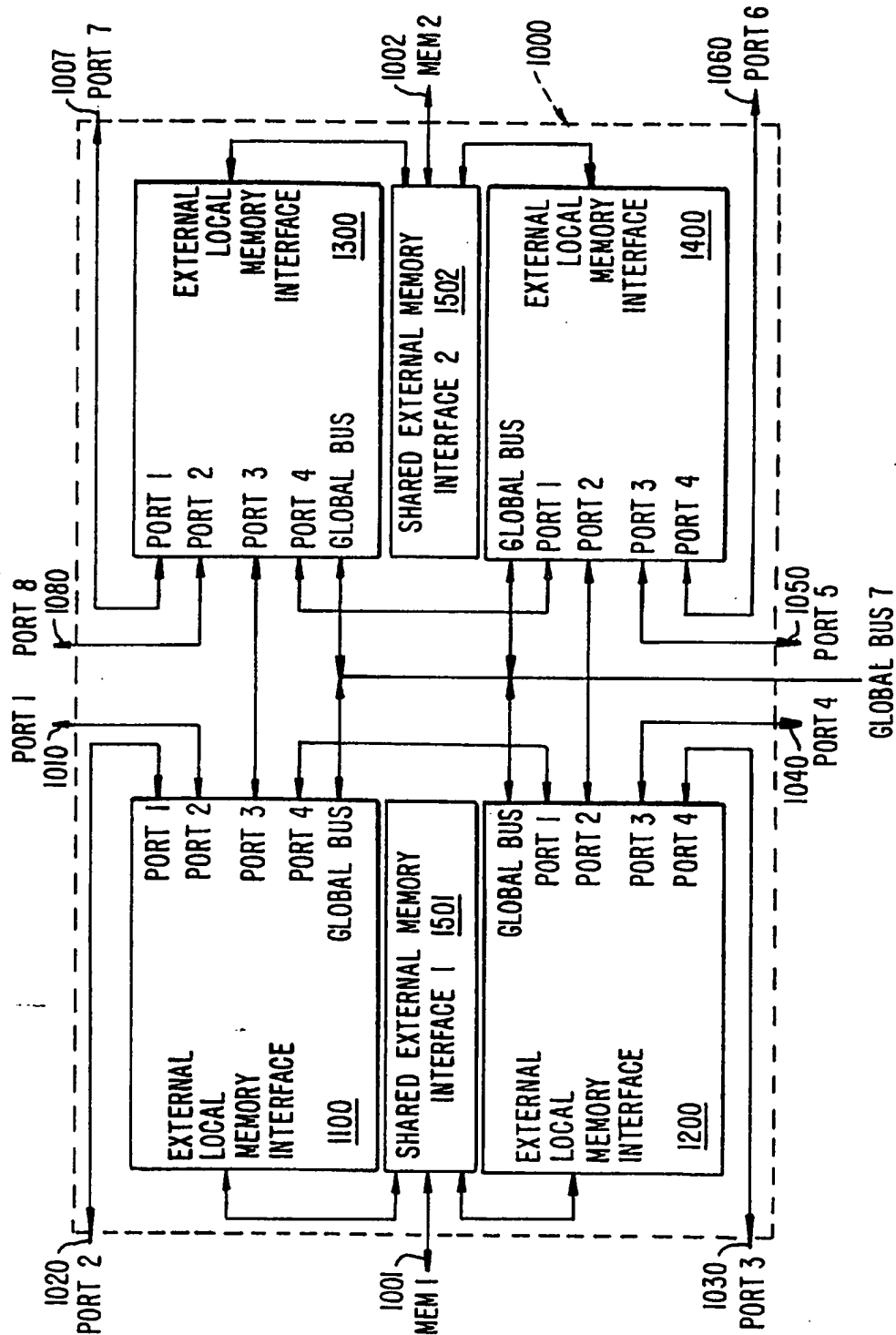


FIG. 9.

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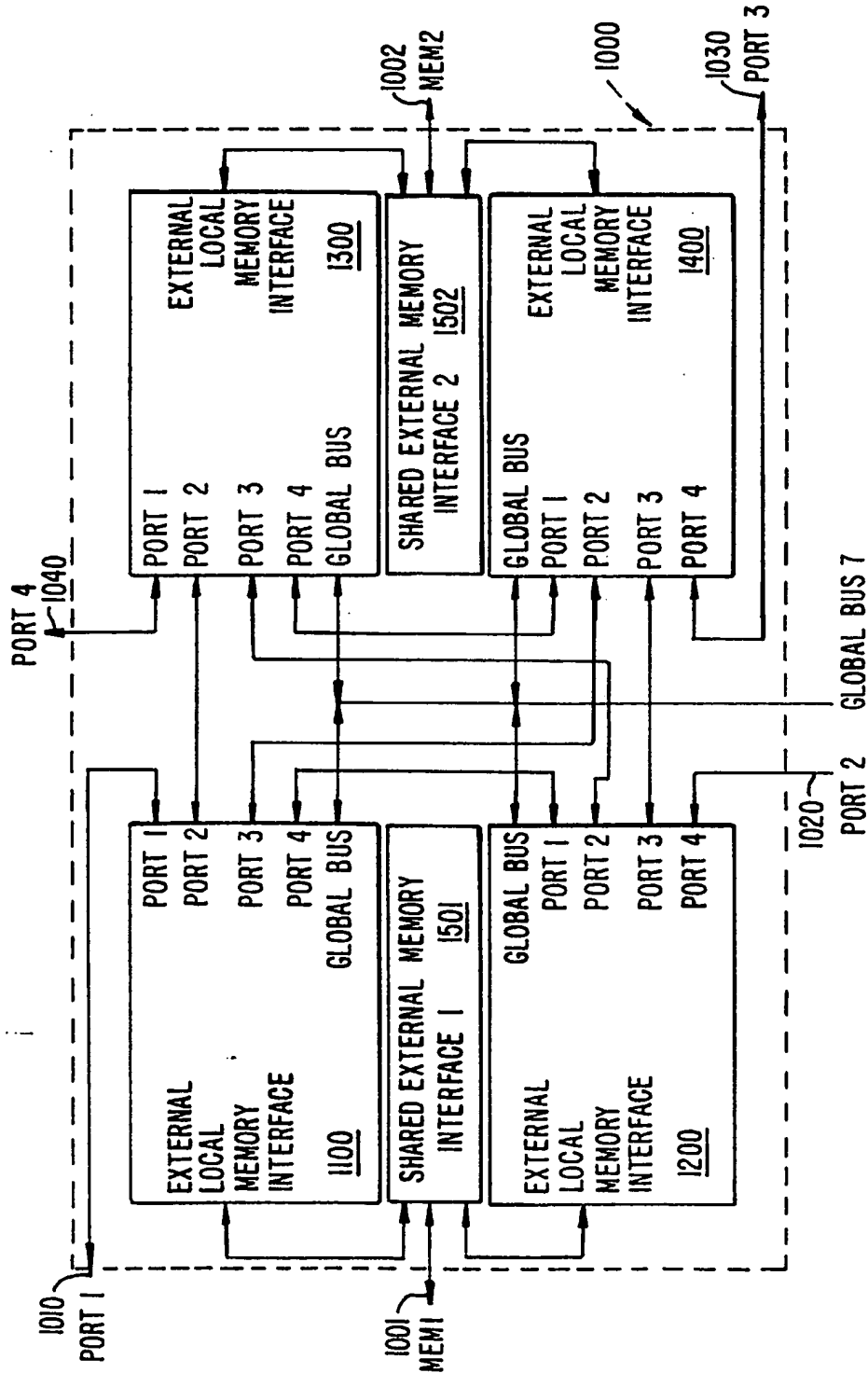


FIG. 10.

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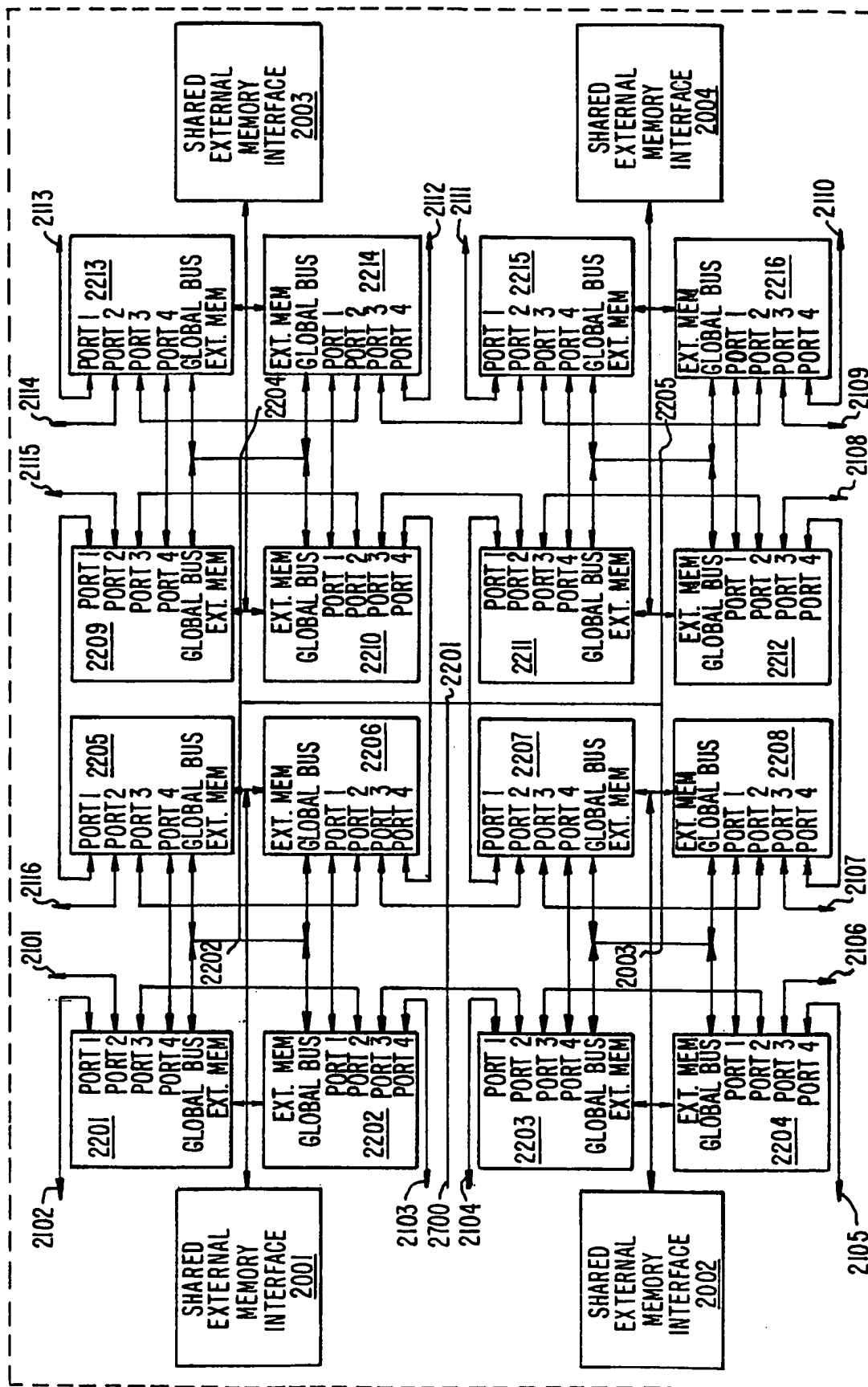


FIG. 11.

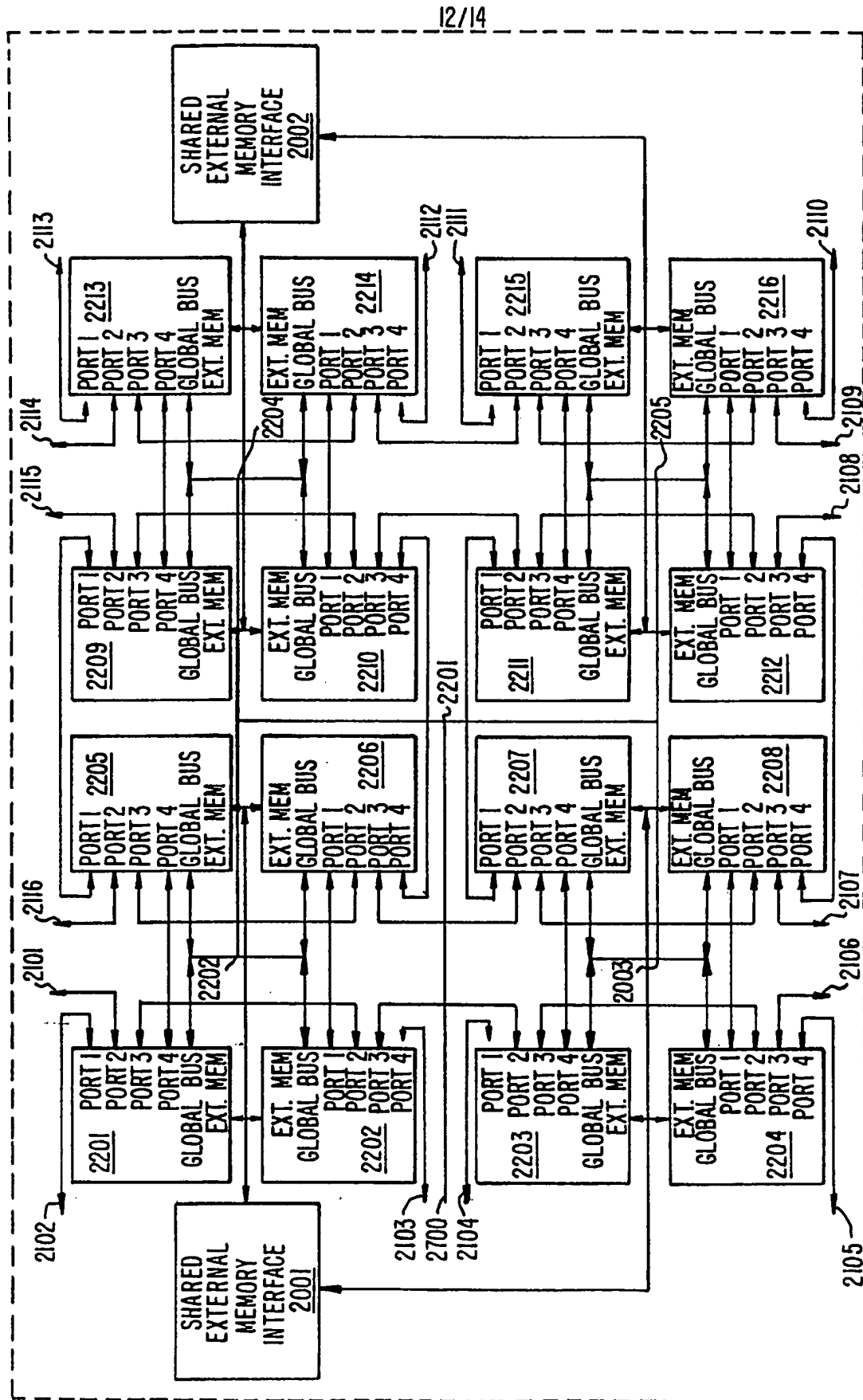


FIG. 12.

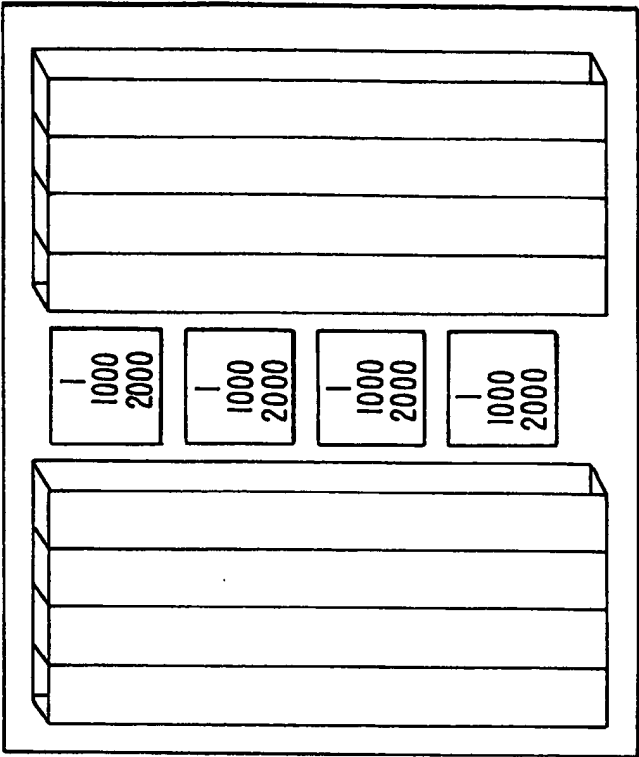


FIG. 13.

- OVERALL PCB FOOT PRINT:
125MM * 125MM
- EACH SIDE OF PRINTED CIRCUIT BOARD CONTAINS:
 - (4) EMBODIMENTS
 - (8) SYNCHRONOUS DRAM MODULES (168 PIN) WITH UP TO 16M BY 72 BITS EACH
 - EACH EMBODIMENT HAS 288 MBYTES OF RAM
 - BOOT ROM AND OTHER SUPPORT CIRCUITRY IS NOT DIAGRAMMED HERE

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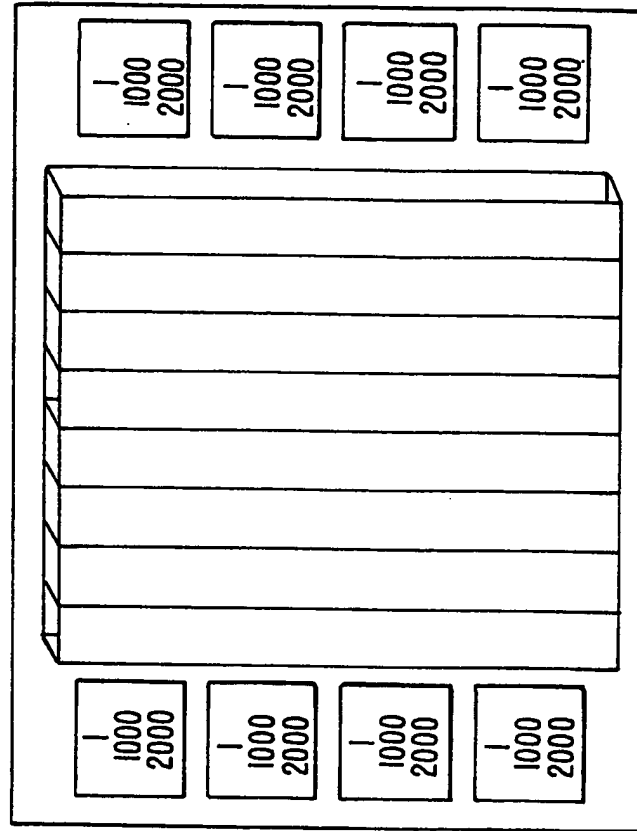


FIG. 14.

- OVERALL PCB FOOT PRINT:
125MM * 150MM
- EACH SIDE OF PRINTED CIRCUIT BOARD CONTAINS:
 - (8) EMBODIMENTS
 - (8) SYNCHRONOUS DRAM MODULES (168 PIN) WITH UP TO 16M BY 72 BITS EACH
 - EACH EMBODIMENT HAS 144 MBYTES OF RAM
 - BOOT ROM AND OTHER SUPPORT CIRCUITRY IS NOT DIAGRAMMED HERE

INTERNATIONAL SEARCH REPORT

International application No.
PCT/US97/23849

A. CLASSIFICATION OF SUBJECT MATTER

IPC(6) :G06F 15/16, 15/163, 15/167, 15/17

US CL :Please See Extra Sheet.

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

U.S. : 395/800.1, 800.11, 800.16, 800.17, 800.32, 800.33, 800.34, 800.35, 800.36, 800.38, 825, 290; 364/131; 345/519

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

APS, IEEE

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	HIRONORI YAMAUCHI, Architecture and Implementation of a Highly Parallel Single-Chip Video DSP, IEEE Transactions on Circuits and Systems for Video Technology, Vol. 2, No. 2, June 1992. pages 209-210, 213-216.	1-2
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Y		3-4
Y		1-2
Y, P		1-4
Y		1-4
Y	US 5,293,586 A (YAMAZAKI ET AL) 08 March 1994, Figs 1, 12B.	1-2
Y, P	US 5,630,153 A (INTRATER ET AL) 13 May 1997. Figs. 2-3.	1-4
Y	US 4,860,191 A (NOMURA ET AL) 22 August 1989, Figs 4-5.	1-4
Y	US 4,594,651 A (JASWA ET AL) 10 June 1986, Figs 1-2.	1-4

☒ Further documents are listed in the continuation of Box C. ☐ See patent family annex.

* Special categories of cited documents: -	*T* later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
A document defining the general state of the art which is not considered to be of particular relevance	*X* document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
B earlier document published on or after the international filing date	*Y* document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art
L document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)	*A* document member of the same patent family
O document referring to an oral disclosure, use, exhibition or other means	
P document published prior to the international filing date but later than the priority date claimed	

Date of the actual completion of the international search

31 MARCH 1998

Date of mailing of the international search report

07 MAY 1998

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INTERNATIONAL SEARCH REPORT

International application No.

PCT/US97/23849

C (Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	US 4,799,144A (PARRUCK ET AL) 17 January 1989, Fig. 1.	1-4
Y	OHAD FALIK, NSC's Digital Answering Machines Solution, IEEE International Conference on Computer Design, October 1992, Fig. 5.	1-2

INTERNATIONAL SEARCH REPORT

International application No.

PCT/US97/23849

A. CLASSIFICATION OF SUBJECT MATTER:

US CL :

395/800.1, 800.11, 800.16, 800.17, 800.32, 800.33, 800.34, 800.35, 800.36, 800.38, 825, 290; 364/131; 345/519